

Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				•
IGBT thermal resistance,	R _{thJC}		0.9	K/W
junction – case				
Thermal resistance,	R_{thJA}		40	
junction – ambient ¹⁾				

Electrical Characteristic, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol Cond	Conditions	Value			Unit
raianietei		Conditions	min.	Тур.	max.	Joint
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE}$ =0V, $I_{\rm C}$ =500 μ A	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{\rm GE} = 15 \rm V, I_{\rm C} = 15 \rm A$				
		<i>T</i> _j =25°C	1.7	2	2.4	
		T _j =150°C	-	2.3	2.8	
Gate-emitter threshold voltage	$V_{\rm GE(th)}$	$I_{\rm C}$ =400 μ A, $V_{\rm CE}$ = $V_{\rm GE}$	3	4	5	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μΑ
		<i>T</i> _j =25°C	-	-	40	
		T _j =150°C	-	-	2000	
Gate-emitter leakage current	I _{GES}	V _{CE} =0V, V _{GE} =20V	-	-	100	nA
Transconductance	g_{fs}	$V_{\rm CE}$ =20V, $I_{\rm C}$ =15A	3	10.9	-	S
Dynamic Characteristic						
Input capacitance	Ciss	V _{CE} =25V,	1	800	960	pF
Output capacitance	Coss	$V_{GE}=0V$,	-	84	101	
Reverse transfer capacitance	Crss	f=1MHz	-	52	62	
Gate charge	Q _{Gate}	$V_{\rm CC}$ =480V, $I_{\rm C}$ =15A	-	76	99	nC
		V _{GE} =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current ²⁾	I _{C(SC)}	V_{GE} =15V, t_{SC} ≤10 μ s V_{CC} ≤ 600V, T_{j} ≤ 150°C	-	150	-	A

 $^{^{1)}}$ Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for collector connection. PCB is vertical without blown air. $^{2)}$ Allowed number of short circuits: <1000; time between short circuits: >1s.



Switching Characteristic, Inductive Load, at T_j =25 °C

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	Julii
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_j = 25^{\circ}\text{C}$	-	32	38	ns
Rise time	t _r	$V_{CC} = 400 \text{V}, I_{C} = 15 \text{A}, V_{GF} = 0/15 \text{V},$	1	23	28	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =21 Ω ,	ı	234	281	
Fall time	t_{f}	$L_{\sigma}^{(1)}$ =180nH, $C_{\sigma}^{(1)}$ =250pF Energy losses include	-	46	55	
Turn-on energy	Eon		1	0.30	0.36	mJ
Turn-off energy	E_{off}	"tail" and diode	-	0.27	0.35	
Total switching energy	E _{ts}	reverse recovery.	-	0.57	0.71	

Switching Characteristic, Inductive Load, at T_j =150 °C

Parameter	Cumbal	Conditions	Value			I I mit
	Symbol		min.	typ.	max.	Unit
IGBT Characteristic	·					
Turn-on delay time	t _{d(on)}	$T_{\rm j}$ =150°C $V_{\rm CC}$ =400V, $I_{\rm C}$ =15A, $L_{\sigma}^{(1)}$ =180nH,	-	31	38	ns
Rise time	t_{r}		-	23	28	
Turn-off delay time	$t_{d(off)}$	C_{σ}^{-1} =250pF	-	261	313	
Fall time	t _f	$V_{\rm GE} = 0/15 V$,	-	54	65	
Turn-on energy	Eon	$R_{\rm G}$ =21 Ω Energy losses include	-	0.45	0.54	mJ
Turn-off energy	E _{off}	"tail" and diode	-	0.41	0.53	
Total switching energy	E _{ts}	reverse recovery.	-	0.86	1.07	

 $^{^{1)}}$ Leakage inductance L $_{\sigma}$ and Stray capacity C $_{\sigma}$ due to dynamic test circuit in Figure E.



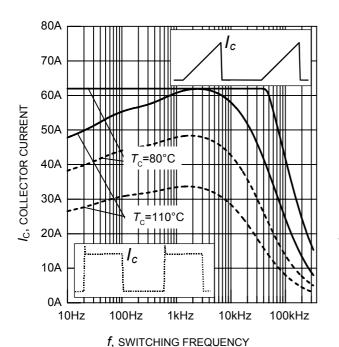


Figure 1. Collector current as a function of switching frequency

 $(T_{\rm j} \le 150^{\circ}{\rm C}, \, D = 0.5, \, V_{\rm CE} = 400{\rm V}, \ V_{\rm GE} = 0/+15{\rm V}, \, R_{\rm G} = 21\Omega)$

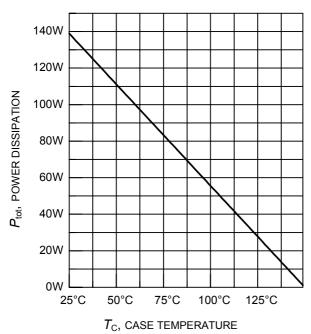
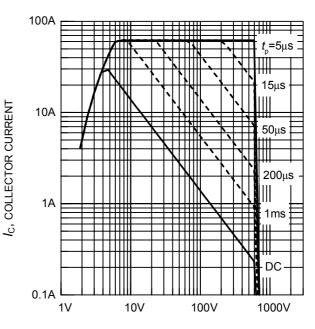


Figure 3. Power dissipation as a function of case temperature

 $(T_{\rm j} \leq 150^{\circ}{\rm C})$



 V_{CE} , COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area $(D = 0, T_C = 25^{\circ}C, T_i \le 150^{\circ}C)$

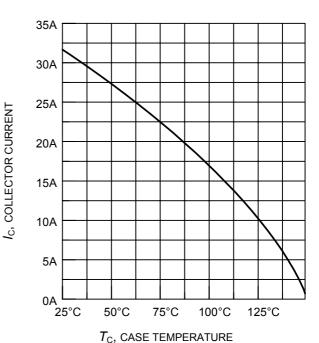


Figure 4. Collector current as a function of case temperature

 $(V_{GE} \le 15V, T_{j} \le 150^{\circ}C)$



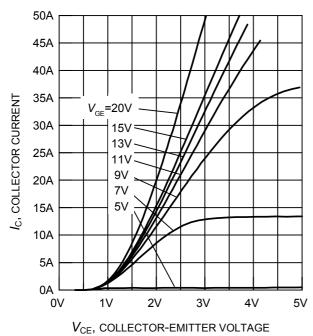


Figure 5. Typical output characteristics $(T_i = 25^{\circ}C)$

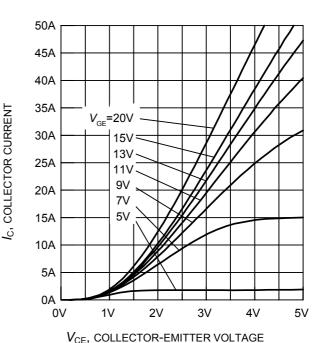


Figure 6. Typical output characteristics ($T_i = 150^{\circ}\text{C}$)

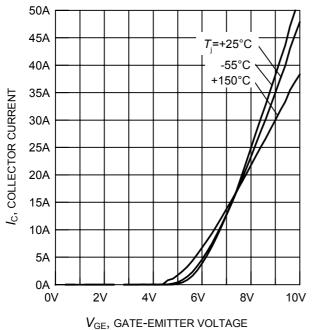


Figure 7. Typical transfer characteristics ($V_{CE} = 10V$)

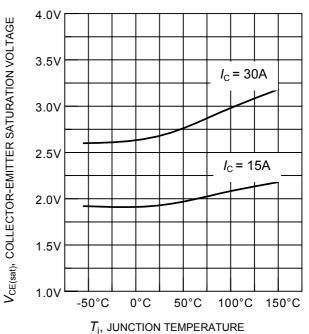


Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature ($V_{\rm GE} = 15 \rm V$)



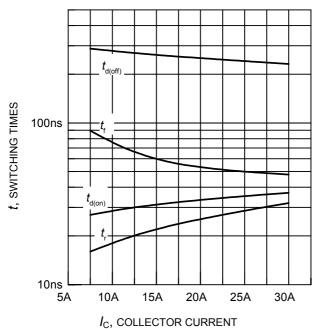
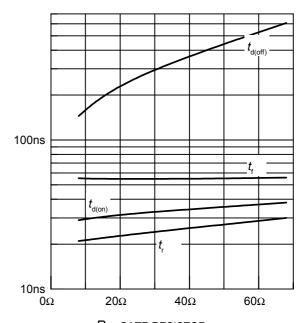


Figure 9. Typical switching times as a function of collector current (industive load, $T = 150^{\circ}\text{C}$, $V_{col} = 400\text{V}$

(inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $R_{\rm G}$ = 21 Ω , Dynamic test circuit in Figure E)



t, SWITCHING TIMES

 $R_{
m G}$, gate resistor

Figure 10. Typical switching times as a function of gate resistor

(inductive load, $T_{\rm j}$ = 150°C, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 15A, Dynamic test circuit in Figure E)

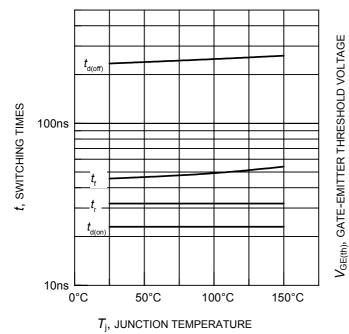
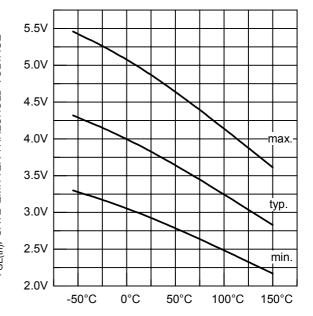


Figure 11. Typical switching times as a function of junction temperature (inductive load, $V_{\rm CE}$ = 400V, $V_{\rm GE}$ = 0/+15V, $I_{\rm C}$ = 15A, $R_{\rm G}$ = 21 Ω ,

Dynamic test circuit in Figure E)



 $T_{\rm j}$, JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature

 $(I_{\rm C} = 0.4 {\rm mA})$



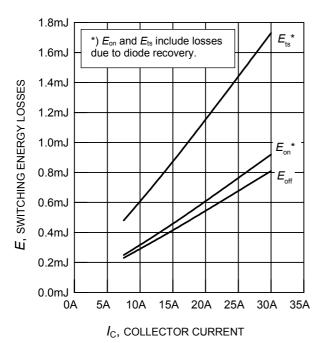


Figure 13. Typical switching energy losses as a function of collector current (inductive load, $T_j = 150^{\circ}\text{C}$, $V_{\text{CE}} = 400\text{V}$, $V_{\text{CE}} = 0.415\text{V}$, $R_{\text{CE}} = 210$

 $V_{\rm GE}$ = 0/+15V, $R_{\rm G}$ = 21 Ω , Dynamic test circuit in Figure E)

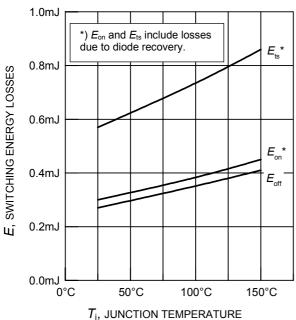


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load, V_{CE} = 400V, V_{GE} = 0/+15V, I_{C} = 15A, R_{G} = 21 Ω , Dynamic test circuit in Figure E)

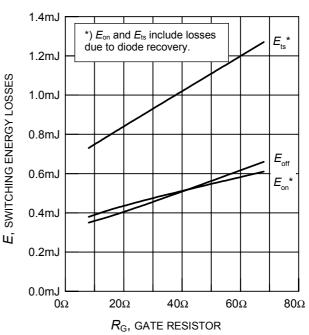


Figure 14. Typical switching energy losses as a function of gate resistor

(inductive load, $T_j = 150$ °C, $V_{CE} = 400$ V, $V_{GE} = 0/+15$ V, $I_C = 15$ A, Dynamic test circuit in Figure E)

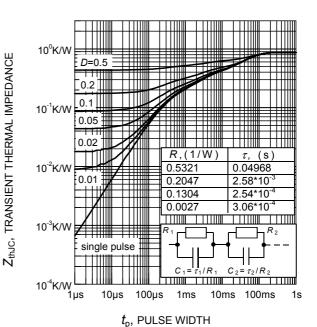


Figure 16. IGBT transient thermal impedance as a function of pulse width $(D = t_p / T)$



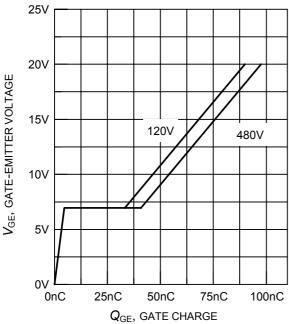
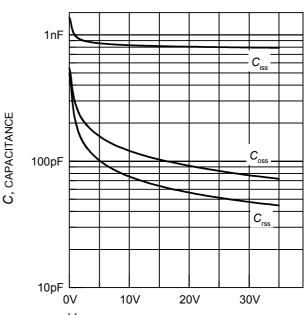


Figure 17. Typical gate charge $(I_C = 15A)$



 $V_{\rm CE}$, COLLECTOR-EMITTER VOLTAGE Figure 18. Typical capacitance as a function of collector-emitter voltage ($V_{\rm GE}=0\rm{V}$, $f=1\rm{MHz}$)

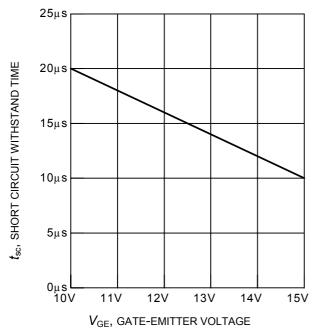


Figure 19. Short circuit withstand time as a function of gate-emitter voltage ($V_{CE} = 600V$, start at $T_i = 25^{\circ}C$)

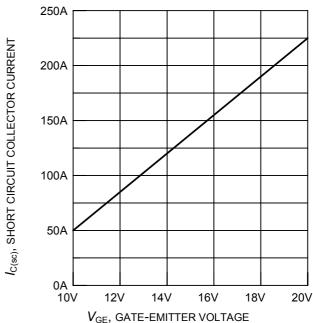
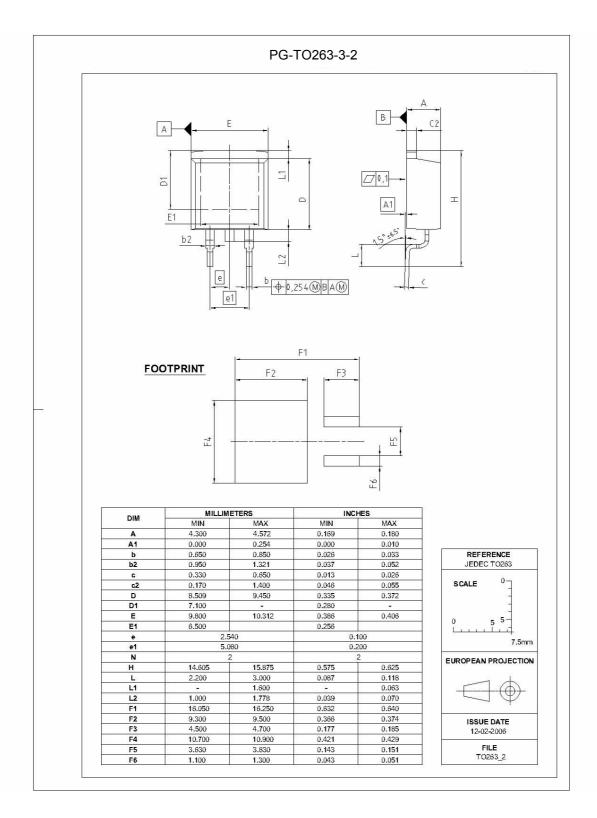


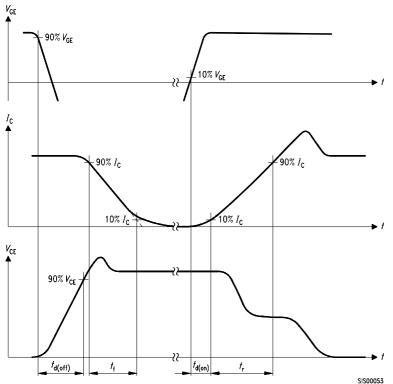
Figure 20. Typical short circuit collector current as a function of gate-emitter voltage ($V_{CE} \le 600V$, $T_i = 150^{\circ}C$)





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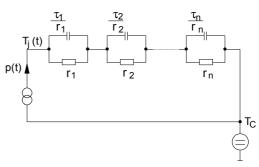


Figure D. Thermal equivalent circuit

Figure A. Definition of switching times

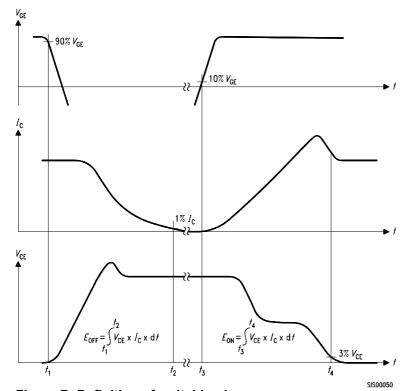


Figure B. Definition of switching losses

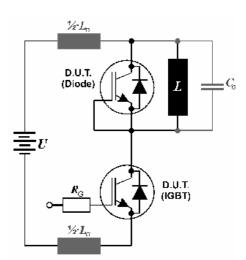


Figure E. Dynamic test circuit Leakage inductance L_{σ} =180nH and Stray capacity C_{σ} =250pF.



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